NPC

OVERVIEW

The 5075 series are miniature VCXO ICs that provide a wide frequency pulling range, even when using miniature crystal units for which a wide pulling range is difficult to provide. They employ a recently developed varicap diode fabrication process that provides a wide frequency pulling range and good linearity without any external components. Also, they employ a regulated voltage drive oscillator circuit that significantly reduces current consumption, crystal current, and oscillation characteristics supply voltage dependency. The 5075 series are ideal for miniature, wide pulling range, low power consumption, VCXO modules.

FEATURES

- VCXO with recently developed varicap diode built-in
- New fabrication process that significantly reduces parasitic capacitance and provides wide pulling range even when using miniature crystal units
- Regulated voltage drive oscillator circuit for reduced power consumption, crystal drive current, and oscillation characteristics voltage dependency
- Wide frequency pulling range
 - ± 190ppm (B1 version, f = 27MHz) (Crystal: γ = 300, C0 = 1.5pF)
- Operating supply voltage range: 2.25V to 3.63V
- Oscillation frequency range (for fundamental oscillation): 20MHz to 55MHz (varies with version)

- Low current consumption: 1.0mA (B1 version, f = 27MHz, no load, V_{DD} = 3.3V)
- Frequency divider built-in
 - Selectable by version: f_0 , $f_0/2$, $f_0/4$, $f_0/8$, $f_0/16$
 - Frequency divider output for 1.3MHz (min) low frequency output
- VC pin input resistance: 10MΩ (min)
- CMOS output
- Two types of pad layout selectable by mounting method
 - A× version: for Flip Chip Bonding
 - $B \times$ version: for Wire Bonding
- Package: Wafer form (WF5075××) Chip form (CF5075××)

APPLICATIONS

■ 2.5 × 2.0mm, 3.2 × 2.5mm size miniature VCXO modules for digital mobile TV tuner, digital TV (PDP, LCD), PND (Personal Navigation Device), etc.

ORDERING INFORMATION

Device	Package
WF5075××-4	Wafer form
CF5075××-4	Chip form

SERIES CONFIGURATION

Operating	DAD lowest	Recommended	Output frequency and version name ^{*2}						
range [V]	PAD layout	range ^{*1} [MHz]	f _O output	f _O /2 output	f _O /4 output	f _O /8 output	f _O /16 output		
2.25 to 3.63	Flip Chip Bonding	20 to 40	(5075A1)	(5075A2)	(5075A3)	(5075A4)	(5075A5)		
		40 to 55	(5075AJ)	(5075AK)	(5075AL)	(5075AM)	(5075AN)		
	Wire Bonding	20 to 40	5075B1	(5075B2)	(5075B3)	(5075B4)	(5075B5)		
		40 to 55	5075BJ	(5075BK)	(5075BL)	(5075BM)	(5075BN)		

*1. The recommended operating frequency is a yardstick value derived from the crystal used for NPC characteristics authentication. However, the oscillation frequency range is not guaranteed. Specifically, the characteristics can vary greatly due to crystal characteristics and mounting conditions, so the oscillation characteristics of components must be carefully evaluated.

*2. Versions in parentheses () are under development.

VERSION NAME

Device	Package	Version name				
WF5075××-4	Wafer form					
CF5075××-4	Chip form	Form WF: Wafer form Oscillation frequency range, frequency divider function CF: Chip (Die) form Pad layout type A: for Flip Chip Bonding B: for Wire Bonding				

PAD LAYOUT

(Unit: μm)

■ 5075A× (for Flip Chip Bonding)



PAD DIMENSIONS PIN DESCRIPTION

■ 5075B× (for Wire Bonding)



Pad dimensions [µm]		sions [µm]	Pac	l No.	Din	1/0	Description	
Pau NO.	x	Y	5075 A ×	5075B×		1/0	Description	
1	-189	-240	1	2	XT	I	Crystal connection pin (amplifier input)	
2	189	-240	2	1	XTN	0	Crystal connection pin (amplifier output)	
3	315	-21	3	6	VDD	-	(+) supply pin	
4	315	225	4	5	Q	0	Clock output pin	
5	-315	225	5	4	VSS	-	(–) supply pin	
6	-315	-21	6	3	VC	I	Oscillation frequency control voltage input pin (positive polarity) (frequency increases with increasing voltage)	

BLOCK DIAGRAM



*1. N = 1, 2, 4, 8, 16

ABSOLUTE MAXIMUM RATINGS

 $V_{SS} = 0V$

Parameter	Symbol	Conditions	Rating	Unit
Supply voltage range	V _{DD}	Between VDD and VSS	-0.5 to 7.0	V
Input voltage range	V _{IN}	Input pins	–0.5 to V _{DD} + 0.5	V
Output voltage range	V _{OUT}	Output pins	–0.5 to V _{DD} + 0.5	V
Storage temperature range	T _{STG}	Wafer form, chip form	-65 to +150	°C
Output current	I _{OUT}	Q pin	20	mA

RECOMMENDED OPERATING CONDITIONS

 $V_{SS} = 0V$

Deremeter	Symbol	Conditions			l l mit		
Falameter	Symbol			Min	Тур	Max	
Operating supply voltage	V _{DD}	$C_{LOUT} \le 15 pF$		2.25	-	3.63	V
Input voltage	V _{IN}	Input pins		V _{SS}	-	V _{DD}	V
Operating temperature	T _{OPR}			-40	-	+85	°C
Oscillation frequency ^{*1}	fo	5075×1 to 5075×5		20	-	40	MHz
		5075×J to 5075×N		40	-	55	MHz
Output frequency	f _{OUT}		5075×1 to 5075×5	1.25	-	40	MHz
		CLOUT ≥ 15PF	5075×J to 5075×N	2.5	-	55	MHz

*1. The oscillation frequency is a yardstick value derived from the crystal used for NPC characteristics authentication. However, the oscillation frequency range is not guaranteed. Specifically, the characteristics can vary greatly due to crystal characteristics and mounting conditions, so the oscillation characteristics of components must be carefully evaluated.

ELECTRICAL CHARACTERISTICS

5075×1 to 5075×5

 V_{DD} = 2.25 to 3.63V, V_{C} = 0.5 V_{DD} , V_{SS} = 0V, Ta = -40 to +85°C unless otherwise noted.

Devenueter	Cumhal	Oandikiana		Unit			
Parameter	Symbol	Conditions	Min	Тур	Max	Unit	
		5075×1 (f_0), Measurement circuit 1, no load, f_0 = 27MHz, f_{OUT} = 27MHz	V _{DD} = 2.5V	-	0.7	1.4	mA
			V _{DD} = 3.3V	-	1.0	2.0	mA
		5075×2 (f _O /2), Measurement circuit 1,	V _{DD} = 2.5V	-	0.6	1.2	mA
		no load, $f_0 = 27MHz$, $f_{OUT} = 13.5MHz$	V _{DD} = 3.3V	-	0.8	1.6	mA
Current consumption	1	5075×3 (f _O /4), Measurement circuit 1,	V _{DD} = 2.5V	-	0.5	1.0	mA
Current consumption	DD	no load, $f_0 = 27MHz$, $f_{OUT} = 6.75MHz$	V _{DD} = 3.3V	-	0.7	1.4	mA
		5075×4 (f _O /8), Measurement circuit 1,	V _{DD} = 2.5V	-	0.5	1.0	mA
		no load, $f_0 = 27$ MHz, $f_{OUT} = 3.38$ MHz	V _{DD} = 3.3V	-	0.6	1.2	mA
		5075×5 (f_O /16), Measurement circuit 1, no load, f_O = 27MHz, f_{OUT} = 1.69MHz	V _{DD} = 2.5V	-	0.4	0.8	mA
			V _{DD} = 3.3V	-	0.6	1.2	mA
HIGH-level output voltage	V _{OH}	Q pin, Measurement circuit 2, I _{OH} = -2.8	V _{DD} - 0.4	-	-	V	
LOW-level output voltage	V _{OL}	Q pin, Measurement circuit 2, I _{OL} = 2.8r	-	-	0.4	V	
Oscillator block built-in resistance	R _{VC1}	Measurement circuit 3	210	420	840	kΩ	
	R _{VC2}		210	420	840	kΩ	
			V _C = 0.3V	-	5.6	-	pF
	C _{VC1}		V _C = 1.65V	-	3.1	-	pF
Oscillator block built-in		Design value (a monitor pattern on a	V _C = 3.0V	-	1.5	-	pF
capacitance		capacitance.	V _C = 0.3V	-	8.4	-	pF
	C _{VC2}		V _C = 1.65V	-	4.7	-	pF
			V _C = 3.0V	-	2.3	-	pF
VC input resistance	R _{VIN}	Measurement circuit 4, Ta = 25°C		10	-	-	MΩ
VC input impedance	Z _{VIN}	Measurement circuit 5, $V_C = 0V$, f = 10kHz, Ta = 25°C (a monitor pattern on a wafer is tested)		-	450	-	kΩ
VC input capacitance	C _{VIN}	Measurement circuit 5, $V_C = 0V$, f = 10kl (a monitor pattern on a wafer is tested)	Hz, Ta = 25°C	-	37	-	pF
Modulation characteristics ^{*1}	fm	Measurement circuit 6, –3dB frequency, $V_C = 3.3Vp$ -p, Ta = 25°C, f _O = 27MHz	V _{DD} = 3.3V,	-	25	_	kHz

*1. The modulation characteristics may vary with the crystal used.

5075×J to 5075×N

Demonster	0 mb at	O an altitude a		1			
Parameter	Symbol	Conditions	Min	Тур	Мах	Omit	
		5075×J (f _O), Measurement circuit 1,	V _{DD} = 2.5V	-	1.2	2.4	mA
		no load, $f_0 = 48MHz$, $f_{OUT} = 48MHz$	V _{DD} = 3.3V	-	1.6	3.2	mA
		5075×K (f ₀ /2). Measurement circuit 1.	V _{DD} = 2.5V	-	0.9	1.8	mA
Parameter Current consumption HIGH-level output voltage LOW-level output voltage Oscillator block built-in resistance Oscillator block built-in capacitance VC input resistance VC input impedance VC input capacitance		no load, $f_0 = 48MHz$, $f_{OUT} = 24MHz$	V _{DD} = 3.3V	-	1.3	2.6	mA
Current concurrention		5075×L (f ₀ /4), Measurement circuit 1,	V _{DD} = 2.5V	-	0.8	1.6	mA
Current consumption	DD	no load, $f_0 = 48MHz$, $f_{OUT} = 12MHz$	V _{DD} = 3.3V	-	1.0	2.0	mA
		5075×M (f _O /8), Measurement circuit 1,	V _{DD} = 2.5V	-	0.7	1.4	mA
		no load, $f_0 = 48MHz$, $f_{OUT} = 6MHz$	V _{DD} = 3.3V	-	0.9	1.8	mA
		5075×N (f _O /16), Measurement circuit 1, no load, f _O = 48MHz, f _{OUT} = 3MHz	V _{DD} = 2.5V	-	0.7	1.4	mA
			V _{DD} = 3.3V	-	0.9	1.8	mA
HIGH-level output voltage	V _{OH}	Q pin, Measurement circuit 2, I _{OH} = -2.8	V _{DD} - 0.4	-	-	V	
LOW-level output voltage	V _{OL}	Q pin, Measurement circuit 2, I _{OL} = 2.8m	-	-	0.4	V	
Oscillator block built-in	R _{VC1}	Macouroment aircuit 0	210	420	840	kΩ	
resistance	R _{VC2}	- Measurement circuit 3		210	420	840	kΩ
			V _C = 0.3V	-	5.6	-	pF
	C _{VC1}		V _C = 1.65V	-	3.1	-	pF
Oscillator block built-in		Design value (a monitor pattern on a	$\frac{V_{DD} = 3.3V}{MHz} - 1.0 2.0 mA$ $\frac{V_{DD} = 3.3V}{MHz} - 0.7 1.4 mA$ $\frac{V_{DD} = 3.3V}{V_{DD} = 3.3V} - 0.9 1.8 mA$ $\frac{V_{DD} = 3.3V}{V_{DD} = 3.3V} - 0.9 1.8 mA$ $\frac{V_{DD} = 3.3V}{V_{DD} = 3.3V} - 0.9 1.8 mA$ $\frac{V_{DD} = 3.3V}{V_{DD} = 3.3V} - 0.9 1.8 mA$ $\frac{V_{DD} = -2.8mA}{V_{DD} = -0.4} V$ $\frac{210}{420} 840 k\Omega$ $\frac{210}{420} 840 k\Omega$ $\frac{210}{420} 840 k\Omega$ $\frac{210}{210} 420 840 k\Omega$ $\frac{V_{C} = 0.3V}{V_{C} = 1.65V} - 3.1 - pF$ $\frac{V_{C} = 3.0V}{V_{C} = 0.3V} - 8.4 - pF$ $\frac{V_{C} = 1.65V}{V_{C} = 1.65V} - 4.7 - pF$ $\frac{V_{C} = 3.0V}{V_{C} = 3.0V} - 2.3 - pF$				
capacitance		capacitance.	$V_{\rm C} = 0.3 V$	-	8.4	-	pF
	C _{VC2}		V _C = 1.65V	-	4.7	-	pF
			V _C = 3.0V	-	2.3	-	pF
VC input resistance	R _{VIN}	Measurement circuit 4, Ta = 25°C		10	-	-	MΩ
VC input impedance	Z _{VIN}	Measurement circuit 5, $V_C = 0V$, f = 10kH (a monitor pattern on a wafer is tested)	-	450	-	kΩ	
VC input capacitance	C _{VIN}	Measurement circuit 5, $V_C = 0V$, f = 10kH (a monitor pattern on a wafer is tested)	z, Ta = 25°C	-	37	_	pF
Modulation characteristics ^{*1}	fm	Measurement circuit 6, -3dB frequency, V V _C = 3.3Vp-p, Ta = 25°C, f _O = 48MHz	/ _{DD} = 3.3V,	-	23	-	kHz

 $^{\star}\ensuremath{\text{1}}.$ The modulation characteristics may vary with the crystal used.

SWITCHING CHARACTERISTICS

 V_{DD} = 2.25 to 3.63V, V_C = 0.5 V_{DD} , V_{SS} = 0V, Ta = -40 to +85°C unless otherwise noted.

Devemeter	Cumhol	Symbol Conditions		Rating			
Farameter	Symbol	Conditions	Min	Тур	Max	Unit	
Output rise time	t _r	Measurement circuit 7, 0.2V_{DD} \rightarrow 0.8V_{DD}, C _{LOUT} = 15pF	-	2.1	4.0	ns	
Output fall time	t _f	Measurement circuit 7, 0.8V_{DD} \rightarrow 0.2V_{DD}, C_{LOUT} = 15pF	-	2.1	4.0	ns	
Output duty cycle	Duty	Measurement circuit 7, Ta = 25° C, C _{LOUT} = 15pF, V _{DD} = 3.3V	45	50	55	%	

Switching Time Measurement Waveform



MEASUREMENT CIRCUITS

Measurement Circuit 1

Measurement parameter: I_{DD}



Measurement Circuit 2

Measurement parameter: V_{OH}, V_{OL}



 V_S adjusted such that ΔV = 50 \times I_{OH}.

 V_{S} adjusted such that ΔV = 50 \times $I_{OL}.$

XT input signal: 1Vp-p, sine wave

Measurement Circuit 3

Measurement parameter: RVC1, RVC2



Measurement Circuit 4

Measurement parameter: R_{VIN}



Measurement Circuit 5

Measurement parameter: C_{VIN}, Z_{VIN}



VC input signal: 100Hz to 10kHz, 0.1Vp-p

Measurement Circuit 6

Measurement parameter: fm



C1 = 33 μ F, R1 = R2 = 1M Ω VC modulation signal: 100Hz to 100kHz, 0 to V_{DD}p-p

Measurement Circuit 7

Measurement parameter: Duty, t_r, t_f



FUNCTIONAL DESCRIPTION

Oscillation Start-up Detector Function

The devices also feature an oscillation start-up detector circuit. This circuit functions to disable the outputs until the oscillation starts. This prevents unstable oscillator output at oscillator start-up when power is applied.

TYPICAL PERFORMANCE (5075B1)

The following characteristics measured using the crystal below. Note that the characteristics will vary with the crystal used.

Crystal used for measurement















Pulling Sensitivity



 V_{DD} = 2.5V, 3.3V, f_{OUT} = 27MHz, Ta = R.T.



Current Consumption



f_{OUT} = 27MHz, Ta = R.T.

Measurement circuit



Frequency Stability by Supply Voltage Change



 f_{OUT} = 27MHz, \pm 0ppm at V_{DD} = 2.5V



 f_{OUT} = 27MHz, \pm 0ppm at V_{DD} = 3.3V









Negative Resistance



Measurement circuit



Note. "C0" value is set, concerning the actual crystal characteristics connected between XT and XTN. The data is measured with Agilent 4396B using NPC's original measurement jig. The values may vary with measurement jig and conditions.

Measurement circuit



 $\begin{array}{l} \mathsf{DL} = (\mathsf{I}_{X'tal})^2 \times \mathsf{Re} \\ \mathsf{DL:} \ \mathsf{drive} \ \mathsf{level} \\ \mathsf{I}_{X'tal}: \ \mathsf{current} \ \mathsf{flowing} \ \mathsf{to} \ \mathsf{crystal} \ (\mathsf{RMS} \ \mathsf{value}) \\ \mathsf{Re:} \ \mathsf{crystal} \ \mathsf{effective} \ \mathsf{resistance} \end{array}$



V_{DD} = 3.3V, C0 = 2pF, Ta = R.T.

5075 series

Phase Noise







 V_{DD} = 3.3V, f_{OUT} = 27MHz, Ta = R.T.



Modulation Characteristics



 V_{DD} = 2.5V, f_{OUT} = 27MHz, Ta = R.T.



 V_{DD} = 3.3V, f_{OUT} = 27MHz, Ta = R.T.

Measurement circuit



C1 = 33µF, R1 = R2 = 1M Ω VC modulation signal: 100Hz to 100kHz, 0 to V_DDP-p

Output Waveform

Measurement equipment: Oscilloscope; DSO80604B (Agilent)



 $\label{eq:VDD} \begin{array}{l} \mathsf{V}_{\text{DD}} = 2.5 \text{V}, \, 3.3 \text{V}, \, \mathsf{f}_{\text{OUT}} = 27 \text{MHz}, \, \mathsf{V}_{\text{C}} = 0.5 \text{V}_{\text{DD}}, \\ \mathsf{C}_{\text{LOUT}} = 15 \text{pF}, \, \text{Ta} = \text{R.T.} \end{array}$



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NPC

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SEIKO NPC CORPORATION

15-6, Nihombashi-kabutocho, Chuo-ku, Tokyo 103-0026, Japan Telephone: +81-3-6667-6601 Facsimile: +81-3-6667-6611 http://www.npc.co.jp/ Email: sales@npc.co.jp

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